

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Akihiko ENDO et al. Group Art Unit : 2891  
Appl. No. : 10/570,669 Examiner : Asok K SARKAR  
Filed : March 6, 2006 Confirmation No. : 1242  
For : SOI WAFER AND ITS MANUFACTURING METHOD

**FIRST SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT**

Commissioner for Patents  
U.S. Patent and Trademark Office  
Customer Service Window, Mail Stop **AMENDMENT**  
Randolph Building  
401 Dulany Street  
Alexandria, VA 22314

Sir :

In accordance with the duty of disclosure under 37 C.F.R. § 1.56 and §§ 1.97-1.98, and further to the Information Disclosure Statement filed June 14, 2006, Applicants submit herewith a Japanese Office Action dated February 23, 2009, conducted in Japanese Patent Application No. 2005-513881, which is a counterpart of the above-captioned application. This document details the relevance of the following documents, as determined by the Japanese Examiner:

- 1) Japanese Patent Publication No. JP 08-139295, published on May 31, 1996. Applicants note that this document was previously submitted and made of record by the Information Disclosure Statement filed June 14, 2006, and thus, no copy of this document is submitted herewith;
- 2) Japanese Patent Publication No. JP 11-307470, published on November 5, 1999. Applicants note that this document was previously submitted and made of record by the

Information Disclosure Statement filed June 14, 2006, and thus, no copy of this document is submitted herewith;

3) Japanese Patent Publication No. JP 05-226620, published on September 3, 1993.

Applicants note that this document was previously submitted and made of record by the Information Disclosure Statement filed June 14, 2006, and thus, no copy of this document is submitted herewith; and

4) Japanese Patent Publication No. JP 08-037286, published on February 6, 1996.

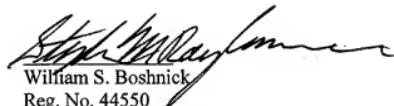
Applicants note that this document was previously submitted and made of record by the Information Disclosure Statement filed June 14, 2006, and thus, no copy of this document is submitted herewith.

Applicants respectfully submit that the foregoing documents have previously been cited by Applicant or the Examiner in the present application, and as such, such information is already of record and no certification is necessary.

No fee is believed necessary to ensure consideration of the submitted material. However, if for any reason a fee is deemed necessary, the Patent and Trademark Office is hereby authorized to charge Deposit Account No. 19-0089 any required fee to ensure consideration of the submitted materials.

If there should be any questions, the Examiner is invited to contact the undersigned at the telephone number listed below.

Respectfully Submitted,  
Akihiko ENDO et al.



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March 5, 2009  
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